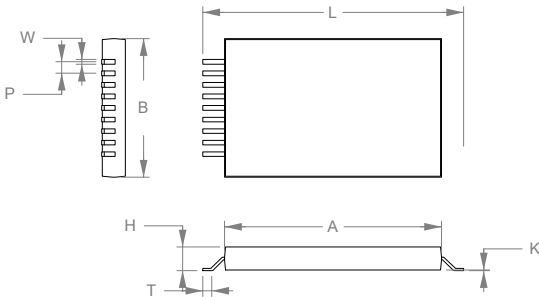


Component (Fig. 1)

Small Outline IC (SOIC)	
Pitch.....	1.00
Pin Package.....	18
Pin Count.....	9
Lmin.....	22.60
Lmax.....	22.60
Tmin.....	0.80
Tmax.....	0.80
Wmin.....	0.40
Wmax.....	0.40
Amin.....	18.80
Amax.....	18.80
Bmin.....	12.00
Bmax.....	12.00
Hmax.....	2.04
Kmin.....	0.05

Fig.1



Solder Joint Goals (Fig. 2)

Environment is A - MOST

Toe (Outside) Goal.....	0.55
Toe min.....	0.55
Toe max.....	0.63
Heel (Inside) Goal.....	0.45
Heel Min.....	0.45
Heel max.....	0.53
Side Goal.....	0.05
Side Min.....	0.05
Side max.....	0.13

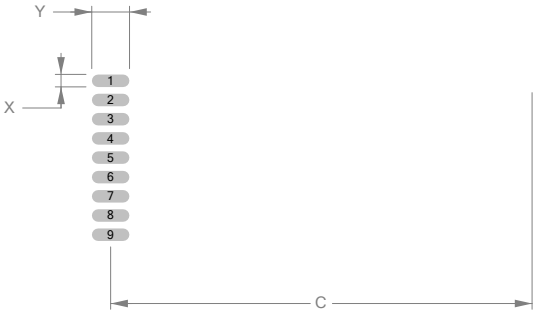
Fig.2



Land Pattern (Fig. 3)

C.....	21.90
Y.....	1.95
X.....	0.65
Pin(s) default	
b195_65	

Fig.3



Silkscreen (Fig. 4)

R1.....19.30
R2.....12.00

Assembly (Fig. 5)

Anom.....18.80
Bnom.....12.00

Courtyard (Fig. 6)

V1.....24.90
V2.....13.00

Program Version: 2010.00.00

Advisories

None

Fig.4

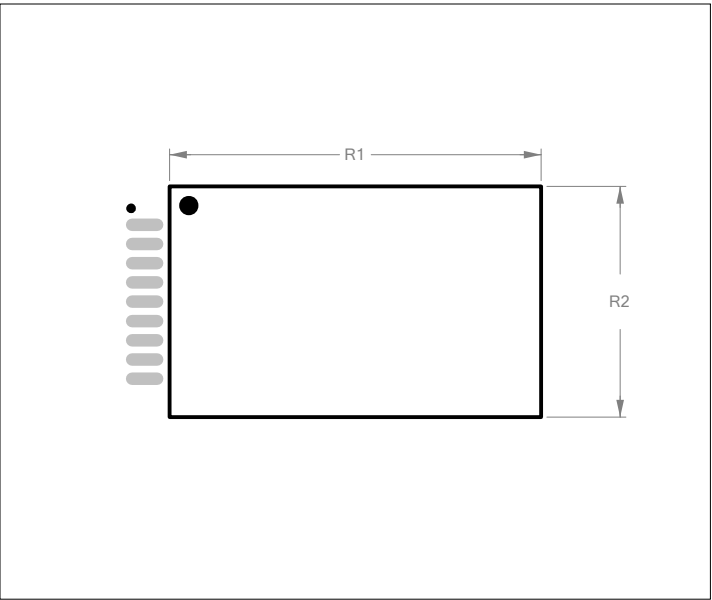


Fig.5

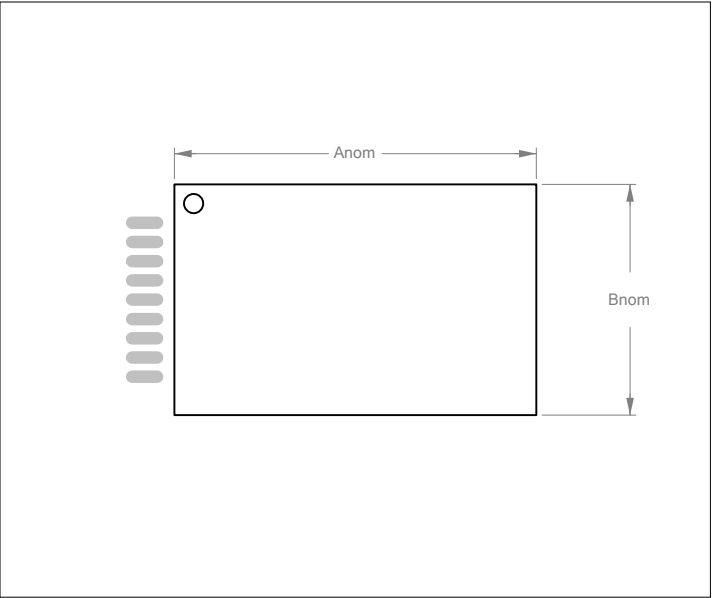


Fig.6

